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Global Radiation-Hardened Electronics Market: Focus on Manufacturing Technique, Component, and End User – Analysis and Forecast, 2020-2025

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Abstracts

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Key Questions Answered in this Report:

What are the trends in the global radiation hardened electronics market across different regions?

What are the major driving forces expected to increase the demand for radiation hardened electronics during the forecast period 2020-2025?

What are the major challenges inhibiting the growth of the radiation hardened electronics market?

What was the revenue generated in the global radiation hardened electronics market by various segments in 2019, and what are the estimates by 2025?

Which end-user of the radiation hardened electronics market (Space, Military, Nuclear Power Plants, Aerospace, Other (Healthcare and Mining)) is expected to dominate the market in the coming years?

What is the estimated revenue to be generated by the global radiation hardened electronics market across different regions (North America, Europe, Asia-Pacific, and Rest-of-the-World) during the forecast period?

Who are the key players in the global radiation hardened electronics market, and what are the new strategies that are being adopted by them to make a mark in the industry?

What major opportunities do the radiation hardened electronics market companies foresee in the next ten years?

What is the impact of COVID-19 on the electronics and manufacturing value chain in upstream, midstream, and downstream parts?

What is the competitive strength of the key leading players in the radiation hardened electronics market?

Global Radiation-Hardened Electronics Market Forecast, 2020-2025

The global radiation-hardened electronics industry analysis by BIS Research projects the market to have growth with CAGR of 3.90% based on the values during the forecast period from 2020 to 2025. The North America region is expected to dominate the market by 2025 with a share of 33.15%. The North America region includes the U.S. and Canada, but the U.S. is expected to acquire a major share in 2025 due to the increase in the investment of companies in the country.

The radiation-hardened electronics market has gained huge importance in the past few years. This is due to the rising demand for commercial COTS applications of rad-hard components. Several agencies and research organizations and industry players are engaged in developing software-defined rad-hard components.

Scope of the Global Radiation-Hardened Electronics Market

The global radiation-hardened electronics market research provides the market information for segmentation such as the manufacturing technique, component, and end user. The market is also divided depending upon the end-user as space, military, nuclear power plants, aerospace, and other (healthcare and mining) where space is sub-segmented in satellite and launch vehicle and the military is sub-segmented as missiles, defense vehicle, and munitions. The market analysis examines the radiation hardened electronics market outlook in terms of the trends, driving forces, opportunities, technological advancements, and competitive benchmarking, among others.

The report further takes into consideration the market and business dynamics, along with the detailed product contribution of the key players operating in the market.

Global Radiation-Hardened Electronics Market Segmentation

The report constitutes an extensive study of the radiation-hardened electronics industry. The report largely focuses on providing market information for radiation hardened electronics covering various segments, manufacturing techniques, components, end-user, and regions. The manufacturing technique included rad-hard by design (RHBD), rad-hard by process (RHBP), and rad-hard by software (RHBS). the component type was classified into microprocessors and controllers, sensors, application-specific integrated circuit (ASIC), field-programmable gate array (FPGA), memory, power sources, discrete semiconductors, analog and mixed signals, others (optoelectronics, rectifiers, and fets). The market is further segmented into five end-use, namely space, military, nuclear power plants, aerospace, other (healthcare and mining).

The radiation-hardened electronics is segregated by region under four major regions, namely North America, Europe, APAC, and Rest-of-the-World. Data for each of these regions (by country) is provided.

Key Companies in the Global Radiation-Hardened Electronics Industry

The key players in the global radiation-hardened electronics market include Analog Devices Inc., BAE System, Cobham PLc, Honeywell, IBM, Infineon, Microchip, Renesas, ST Microelectronics, Texas, Boeing, Xilinx Inc., Maxwell, Psemi Corporation, Teledyne E2v Semiconductors, 3d Plus, Micropac Industries, Inc, Anaren Inc, Tt Electronics Plc, Data Device Corporation (Transdigm), and Solid-State Devices, Inc. (SSDI).

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Contents

Executive Summary

1 MARKET DYNAMICS

1.1 Drivers
1.1.1 Rising Satellite Launches and Deep Space Activities
1.1.2 Establishment of Autonomous Military Operations in Hostile Environment
1.1.3 Growing Demand for Radiation-Hardened Electronics in Nuclear and Healthcare Industry
1.2 Market Restraints
1.2.1 High Initial Investment
1.2.2 Difficulties in Creating Real Testing Environment
1.3 Opportunities
1.3.1 Increasing Demand for COTS Radiation-Hardened Electronics in Different Verticals
1.3.2 Rising Requirement for Reconfigurable Radiation-Hardened Electronics

2 COMPETITIVE INSIGHTS

2.1 Key Market Strategies and Development
2.1.1 Partnerships, Collaborations, Contracts, and M&A
2.1.2 New Product Launches and Other Developments
2.2 Competitive Benchmarking
2.3 Market Share Analysis

3 INDUSTRY ANALYSIS

3.1 Industry Overview
3.2 Comparison of Radiation-Hardened Products Standard Requirements and Regulations (by End User)
3.3 Impact of New Technologies on Radiation-Hardened Electronics in New Space
3.4 Radiation-Hardened Electronics Manufacturers and Certifications
3.5 Patent Analysis
3.6 Supply Chain Analysis
3.7 Impact of COVID-19 On Radiation-Hardened Electronics Market
3.7.1 COVID-19 Effect on Manufacturing Sector

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4 GLOBAL RADIATION-HARDENED ELECTRONICS MARKET, 2020 TO 2025

4.1 Assumptions and Limitations
4.2 Market Overview

5 GLOBAL RADIATION-HARDENED ELECTRONICS MARKET (BY MANUFACTURING TECHNIQUE)

5.1 Market Overview (by Manufacturing Technique)
  5.1.1 Rad-Hard by Design (RHBD)
  5.1.2 Rad-Hard by Process (RHBP)
  5.1.3 Rad-Hard by Software (RHBS)

6 GLOBAL RADIATION-HARDENED ELECTRONICS MARKET (BY COMPONENT)

6.1 Market Overview
  6.1.1 Microprocessors and Controllers
  6.1.2 Discrete Semiconductors
  6.1.3 Power Sources
  6.1.4 Memory
  6.1.5 Field-Programmable Gate Array
  6.1.6 Analog and Mixed Signals
  6.1.7 Sensors
  6.1.8 Application-Specific Integrated Circuit
  6.1.9 Others

7 GLOBAL RADIATION-HARDENED ELECTRONICS MARKET (BY END USER)

7.1 Market Overview
7.2 Space
  7.2.1 Satellite
  7.2.2 Launch Vehicles
7.3 Military
  7.3.1 Missiles
  7.3.2 Defense vehicle
  7.3.3 Munitions
7.4 Nuclear Power Plant
7.5 Aerospace
7.6 Others

8 GLOBAL RADIATION-HARDENED ELECTRONICS MARKET (BY REGION)

8.1 Market Overview
8.2 North America
8.2.1 North America Radiation-Hardened Electronics Market Size (by End User)
8.2.2 North America Radiation-Hardened Electronics Market Size (by Component)
8.2.3 North America Radiation-Hardened Electronics Market Size (by Manufacturing Technique)
8.2.4 North America Radiation-Hardened Electronics Market Size (by Country)
8.2.4.1 U.S.
8.2.4.1.1 U.S. Radiation-Hardened Electronics Market (by End User)
8.2.4.1.2 U.S. Radiation-Hardened Electronics Market (by Component)
8.2.4.1.3 U.S. Radiation-Hardened Electronics Market (by Manufacturing Technique)
8.2.4.2 Canada
8.2.4.2.1 Canada Radiation-Hardened Electronics Market (by End User)
8.2.4.2.2 Canada Radiation-Hardened Electronics Market (by Component)
8.2.4.2.3 Canada Radiation-Hardened Electronics Market (by Manufacturing Technique)
8.3 Europe
8.3.1 Europe Radiation-Hardened Electronics Market (by End User)
8.3.2 Europe Radiation-Hardened Electronics Market (by Component)
8.3.3 Europe Radiation-Hardened Electronics Market (by Manufacturing Technique)
8.3.4 Europe (by Country)
8.3.4.1 U.K.
8.3.4.1.1 U.K. Radiation-Hardened Electronics Market (by End User)
8.3.4.2 Germany
8.3.4.2.1 Germany Radiation-Hardened Electronics Market (by End User)
8.3.4.3 France
8.3.4.3.1 France Radiation-Hardened Electronics Market (by End User)
8.3.4.4 Russia
8.3.4.4.1 Russia Radiation-Hardened Electronics Market (by End User)
8.3.4.5 Spain
8.3.4.5.1 Spain Radiation-Hardened Electronics Market (by End User)
8.3.4.6 Rest-of-Europe
8.3.4.6.1 Rest-of-Europe Radiation-Hardened Electronics Market (by End User)
8.4 Asia-Pacific
8.4.1 Asia-Pacific Radiation-Hardened Electronics Market (by End User)

8.4.2 Asia-Pacific Radiation-Hardened Electronics Market (by Component)
8.4.3 Asia-Pacific Radiation-Hardened Electronics Market (by Manufacturing Technique)
8.4.4 Asia-Pacific (by Country)
8.4.4.1 China
8.4.4.1.1 China Radiation-Hardened Electronics Market (by End User)
8.4.4.2 Japan
8.4.4.2.1 Japan Radiation-Hardened Electronics Market (by End User)
8.4.4.3 South Korea
8.4.4.3.1 South Korea Radiation-Hardened Electronics Market (by End User)
8.4.4.4 Australia
8.4.4.4.1 Australia Radiation-Hardened Electronics Market (by End User)
8.4.4.5 India
8.4.4.5.1 India Radiation-Hardened Electronics Market (by End User)
8.4.4.6 Rest-of-Asia-Pacific
8.4.4.6.1 Rest-of-Asia-Pacific Radiation-Hardened Electronics Market (by End User)
8.5 Rest-of-the-World
8.5.1 Rest-of-the-World Radiation-Hardened Electronics Market (by End User)
8.5.2 Rest-of-the-World Radiation-Hardened Electronics Market (by Component)
8.5.3 Rest-of-the-World Radiation-Hardened Electronics Market (by Manufacturing Technique)
8.5.4 Rest-of-the-World Radiation-Hardened Electronics Market (by Country)
8.5.4.1 Brazil
8.5.4.1.1 Brazil Radiation-Hardened Electronics Market (by End User)
8.5.4.2 U.A.E
8.5.4.2.1 U.A.E. Radiation-Hardened Electronics Market (by End User)
8.5.4.3 South Africa
8.5.4.3.1 South Africa Radiation-Hardened Electronics Market (by End User)
8.5.4.4 Mexico
8.5.4.4.1 Mexico Radiation-Hardened Electronics Market (by End User)
8.5.4.5 Others
8.5.4.5.1 Others Radiation-Hardened Electronics Market (by End User)

9 COMPANY PROFILES

9.1 3D Plus (HEICO Corporation)
9.1.1 Company Overview
9.1.2 Financial Overview
9.1.3 Product Portfolio

9.1.4 Strategic Overview
9.1.5 SWOT Analysis of 3D Plus (HEICO Corporation)
9.2 Analog Devices Inc.
9.2.1 Company Overview
9.2.2 Financial Overview
9.2.3 Product Portfolio
9.2.4 Strategic Overview
9.2.4.1 Conferences and Expo
9.2.4.2 Business Collaboration
9.2.5 SWOT Analysis of Analog Devices
9.3 Anaren Inc. (TTM Technologies)
9.3.1 Company Overview
9.3.2 Financial Overview
9.3.3 Product Portfolio
9.3.4 SWOT Analysis: Anaren Inc. (TTM Technologies)
9.4 BAE Systems
9.4.1 Company Overview
9.4.2 Product Portfolio
9.4.3 Financial Overview
9.4.4 Strategic Overview
9.4.4.1 New Product Launch
9.4.5 SWOT Analysis of BAE Systems
9.5 Cobham plc
9.5.1 Company Overview
9.5.2 Financial Overview
9.5.3 Product Portfolio
9.5.4 Business Strategies
9.5.5 SWOT Analysis of Cobham PLC
9.6 Data Device Corporation
9.6.1 Company Overview
9.6.2 Product Portfolio
9.6.3 Business Strategies
9.6.4 SWOT Analysis: Data Device Corporation
9.7 Honeywell International Inc.
9.7.1 Company Overview
9.7.2 Financial Overview
9.7.3 Product Portfolio
9.7.4 Corporate Strategies
9.7.4.1 Contract

9.7.5 SWOT Analysis: Honeywell
9.8 IBM Corporation
9.8.1 Company Overview
9.8.2 Financial Overview
9.8.3 Product Portfolio
9.8.4 SWOT: IBM Corporation
9.9 Infineon Technologies Inc.
9.9.1 Company Overview
9.9.2 Financial Overview
9.9.3 Product Portfolio
9.9.4 Business Strategies
9.9.5 SWOT: Infineon Technologies Inc
9.1 Microchip Technology Inc.
9.10.1 Company Overview
9.10.2 Financial Overview
9.10.3 Product Portfolio
9.10.4 Business Strategies
9.10.5 SWOT: Microchip Technology Inc
9.11 Micropac Industries Inc.
9.11.1 Company Overview
9.11.2 Product Portfolio
9.11.3 Strength and Weakness of Micropac Industries Inc.
9.12 Renesas Electronics Corporation
9.12.1 Company Overview
9.12.2 Financial Overview: Renesas Electronics Corporation
9.12.3 Product Portfolio
9.12.4 Business Strategies
9.12.5 SWOT: Renesas Electronics Corporation
9.13 Solid State Devices Inc.
9.13.1 Company Overview
9.13.2 Product Portfolio
9.13.3 Business Strategies
9.13.3.1 New Product Launch
9.13.4 SWOT: Solid State Devices
9.14 STMicroelectronics N.V
9.14.1 Company Overview
9.14.2 Financial Overview
9.14.3 Product Portfolio
9.14.4 Business Strategies

9.14.5 SWOT: STMicroelectronics N.V.
9.15 Texas Instruments Inc
9.15.1 Company Overview
9.15.2 Financial Overview
9.15.3 Product Portfolio
9.15.4 Business Strategies
9.15.5 SWOT: Texas Instruments Inc.
9.16 Teledyne Technologies Incorporated.
9.16.1 Company Overview
9.16.2 Financial Overview
9.16.3 Product Portfolio
9.16.4 Business Strategies
9.16.5 SWOT: Teledyne Technologies
9.17 The Boeing Company
9.17.1 Company Overview
9.17.2 Financial Overview
9.17.3 Product Portfolio
9.17.4 Business Strategies
9.17.5 SWOT: The Boeing Company.
9.18 Xilinx Inc.
9.18.1 Company Overview
9.18.2 Financial Overview
9.18.3 Product Portfolio
9.18.4 Business Strategies
9.18.5 SWOT: Xilinx Inc
9.19 Other Key Players
9.19.1 AIS Tech Space
9.19.2 Hiber Global
9.19.3 Hera Systems
9.19.4 Helios Wire
9.19.5 Kepler Communications
9.19.6 Swarm Technology
9.19.7 Sen
9.19.8 Unseen Labs

10 RESEARCH SCOPE AND BIS METHODOLOGY

10.1 Scope of the Report
10.2 Global Radiation-Hardened Electronics Market Research Methodology

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11 APPENDIX

11.1 Related Reports

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List Of Tables

LIST OF TABLES

Table 1: Market Snapshot: Global Radiation-Hardened Electronics Market, $Million, 2019 and 2025
Table 2: Comparison between COTS and QML Rad-Hard
Table 3: Partnerships, Collaborations, Contracts, and M&A
Table 4: New Product Launches and Other Developments
Table 5: End User Specification, Requirements
Table 6: List of Certifications
Table 7: Major Patents Granted for Radiation-Hardened Electronics
Table 8: Global Radiation-Hardened Electronics Market (by Manufacturing Technique), $Million, 2019-2025
Table 9: Global Radiation-Hardened Electronics Market (by Component), $Million, 2019-2025
Table 10: Global Radiation-Hardened Electronics Market (by End User), $Million, 2019-2025
Table 11: Global Radiation-Hardened Electronics Market (by Region), $Million, 2019-2025
Table 12: North America Radiation-Hardened Market (by End User), $Million, 2019-2025
Table 13: North America Radiation-Hardened Electronics Market, by End User, $Million, 2019-2025
Table 14: North America Radiation-Hardened Electronics Market, by End User, $Million, 2019-2025
Table 15: North America Radiation-Hardened Electronics Market (by Component), $Million, 2019-2025
Table 16: North America Radiation-Hardened Market (by Manufacturing Technique), $Million, 2019-2025
Table 17: U.S. Radiation-Hardened Electronics Market (by End User), $Million, 2019-2025
Table 18: U.S. Radiation-Hardened Electronics Market, by End User, $Million, 2019-2025
Table 19: U.S. Radiation-Hardened Electronics Market, by End User, $Million, 2019-2025
Table 20: U.S. Radiation-Hardened Electronics Market (by Component), $Million, 2019-2025
Table 21: U.S. Radiation-Hardened Electronics Market (by Manufacturing Technique),

$Million, 2019-2025
Table 22: Canada Radiation-Hardened Electronics Market (by End User), $Million, 2019-2025
Table 23: Canada Radiation-Hardened Electronics Market, by End User, $Million, 2019-2025
Table 24: Canada Radiation-Hardened Electronics Market, by End User, $Million, 2019-2025
Table 25: Canada Radiation-Hardened Electronics Market (by Component), $Million, 2019-2025
Table 26: Canada Radiation-Hardened Electronics Market (by Manufacturing Technique), $Million, 2019-2025
Table 27: Europe Radiation-Hardened Electronics Market (by End User), $Million, 2019-2025
Table 28: Europe Radiation-Hardened Electronics Market, by End User, $Million, 2019-2025
Table 29: Europe Radiation-Hardened Electronics Market, by End User, $Million, 2019-2025
Table 30: Europe Radiation-Hardened Electronics Market (by Component), $Million, 2019-2025
Table 31: Europe Radiation-Hardened Electronics Market (by Manufacturing Technique), $Million, 2019-2025
Table 32: U.K. Radiation-Hardened Electronics Market (by End User), $Million, 2019-2025
Table 33: Germany Radiation-Hardened Electronics Market (by End User), $Million, 2019-2025
Table 34: France Radiation-Hardened Electronics Market (by End User), $Million, 2019-2025
Table 35: Russia Radiation-Hardened Electronics Market (by End User), $Million, 2019-2025
Table 36: Spain Radiation-Hardened Electronics Market (by End User), $Million, 2019-2025
Table 37: Rest-of-Europe Radiation-Hardened Electronics Market (by End User), $Million, 2019-2025
Table 38: Asia-Pacific Radiation-Hardened Electronics Market (by End User), $Million, 2019-2025
Table 39: Asia-Pacific Radiation-Hardened Electronics Market, by End User, $Million, 2019-2025
Table 40: Asia-Pacific Radiation-Hardened Electronics Market, by End User, $Million, 2019-2025

Table 41: Asia-Pacific Radiation-Hardened Electronics Market (by Component), $Million, 2019-2025
Table 42: Asia-Pacific Radiation-Hardened Electronics Market (by Manufacturing Technique), $Million, 2019-2025
Table 43: China Radiation-Hardened Electronics Market (by End User), $Million, 2019-2025
Table 44: Japan Radiation-Hardened Electronics Market (by End User), $Million, 2019-2025
Table 45: South Korea Radiation-Hardened Electronics Market (by End User), $Million, 2019-2025
Table 46: Australia Radiation-Hardened Electronics Market (by End User), $Million, 2019-2025
Table 47: India Radiation-Hardened Electronics Market (by End User), $Million, 2019-2025
Table 48: Rest-of-Asia-Pacific Radiation-Hardened Electronics Market (by End User), $Million, 2019-2025
Table 49: Rest-of-the-World Radiation-Hardened Electronics Market (by End User), $Million, 2019-2025
Table 50: Rest-of-the-World Radiation-Hardened Electronics Market, by End User, $Million, 2019-2025
Table 51: Rest-of-the-World Radiation-Hardened Electronics Market, by End User, $Million, 2019-2025
Table 52: Rest-of-the-World Radiation-Hardened Electronics Market (by Component), $Million, 2019-2025
Table 53: Rest-of-the-World Radiation-Hardened Electronics Market (by Manufacturing Technique), $Million, 2019-2025
Table 54: Brazil Radiation-Hardened Electronics Market (by End User), $Million, 2019-2025
Table 55: U.A.E. Radiation-Hardened Electronics Market (by End User), $Million, 2019-2025
Table 56: South Africa Radiation-Hardened Electronics Market (by End User), $Million, 2019-2025
Table 57: Mexico Radiation-Hardened Electronics Market (by End User), $Million, 2019-2025
Table 58: Others Radiation-Hardened Electronics Market (by End User), $Million, 2019-2025
Table 59: 3D Plus (HEICO Corporation): Product Portfolio
Table 60: Contract
Table 61: Analog Devices: Product Portfolio

Table 62: Conferences and Expo
Table 63: Business Collaboration
Table 64: Anaren Inc. (TTM Technologies): Product Portfolio
Table 65: BAE Systems Product Portfolio
Table 66: New Product Launch
Table 67: Cobham PLC: Product Portfolio
Table 68: Business Strategies
Table 69: Data Device Corporation: Product Portfolio
Table 70: Business Strategies
Table 71: Honeywell International Inc.: Product Portfolio
Table 72: Long Term Contract
Table 73: IBM Corporation Product Portfolio
Table 74: Infineon Technologies Inc.: Product Portfolio
Table 75: Infineon Technologies Inc..: Long Term Agreement
Table 76: Microchip Technology Inc: Product Portfolio
Table 77: Acquisition
Table 78: Micropac Industries Inc.: Product Portfolio
Table 79: Renesas Electronics Corporation: Product Portfolio
Table 80: Product Developments
Table 81: Solid State Devices: Product Portfolio
Table 82: New Product Launch
Table 83: STMicroelectronics N.V.: Product Portfolio
Table 84: New Product Launch
Table 85: Texas Instruments Inc.: Product Portfolio
Table 86: Internal Management
Table 87: Teledyne Technologies Incorporated: Product Portfolio
Table 88: Business Strategies
Table 89: The Boeing Company: Product Portfolio
Table 90: Licensing
Table 91: Xilinx Inc.: Product Portfolio
Table 92: Collaboration

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List Of Figures

LIST OF FIGURES

Figure 1: Global Radiation-Hardened Electronics Market, $Million, 2019-2025
Figure 2: Global Radiation-Hardened Electronics Market (by Manufacturing Technique), $Million, 2019-2025
Figure 3: Global Radiation-Hardened Electronics Market (by Component), $Million, 2019-2025
Figure 4: Global Radiation-Hardened Electronics Market (by End User), $Million, 2019-2025
Figure 5: Global Radiation-Hardened Electronics Market (by Region), 2019-2025
Figure 6: Market Dynamics Snapshot
Figure 7: Satellites Launches, 2014-2019
Figure 8: Key Strategies Adopted by Market Players
Figure 9: Competitive Benchmarking, 2019
Figure 10: Market Share Analysis, 2019
Figure 11: Industry Insights
Figure 12: Supply Chain Analysis, 2019
Figure 13: Global Radiation-Hardened Electronics Market (by Manufacturing Technique)
Figure 14: Global Radiation-Hardened Electronics Market (Rad-Hard by Design), 2019-2025
Figure 15: Global Radiation-Hardened Electronics Market (Rad-Hard by Process), 2019-2025
Figure 16: Global Radiation-Hardened Electronics Market (Rad-Hard by Software), 2019-2025
Figure 17: Global Radiation-Hardened Electronics Market (by Component)
Figure 18: Global Radiation-Hardened Electronics Market (Microprocessors and Controllers), 2019-2025
Figure 19: Global Radiation-Hardened Electronics Market (Discrete Semiconductors), 2019-2025
Figure 20: Global Radiation-Hardened Electronics Market (Power Sources), 2019-2025
Figure 21: Global Radiation-Hardened Electronics Market (Memory), 2019-2025
Figure 22: Global Radiation-Hardened Electronics Market (Field-Programmable Gate Array), 2019-2025
Figure 23: Global Radiation-Hardened Electronics Market (Analog and Mixed Signals), 2019-2025
Figure 24: Global Radiation-Hardened Electronics Market (Sensors), 2019-2025
Figure 25: Global Radiation-Hardened Electronics Market (Application-Specific

Integrated Circuit), 2019-2025
Figure 26: Global Radiation-Hardened Electronics Market (Others), 2019-2025
Figure 27: Global Radiation-Hardened Electronics Market (by End User)
Figure 28: Global Radiation-Hardened Electronics Market (by Space), 2019-2025
Figure 29: Global Radiation-Hardened Electronics Market (by Satellite), 2019-2025
Figure 30: Global Radiation-Hardened Electronics Market (by Launch Vehicle), 2019-2025
Figure 31: Global Radiation-Hardened Electronics Market (by Military), 2019-2025
Figure 32: Global Radiation-Hardened Electronics Market (by Missile), 2019-2025
Figure 33: Global Radiation-Hardened Electronics Market (by Defense Vehicle), 2019-2025
Figure 34: Global Radiation-Hardened Electronics Market (by Munitions), 2019-2025
Figure 35: Global Radiation-Hardened Electronics Market (by Nuclear Power Plant), 2019-2025
Figure 36: Global Radiation-Hardened Electronics Market (by Aerospace), 2019-2025
Figure 37: Global Radiation-Hardened Electronics Market (by Others), 2019-2025
Figure 38: Global Radiation-Hardened Electronics Market (by Region)
Figure 39: Regional Distribution of the Global Radiation-Hardened Electronics Market, 2019 and 2025
Figure 40: North America Radiation-Hardened Electronics Market (by Country), 2019 - 2025
Figure 41: U.S. Radiation-Hardened Electronics Market, 2019-2025
Figure 42: Canada Radiation-Hardened Electronics Market, 2019-2025
Figure 43: Europe Radiation-Hardened Electronics Market, 2019-2025
Figure 44: U.K. Radiation-Hardened Electronics Market, 2019-2025
Figure 45: Germany Radiation-Hardened Electronics Market, 2019-2025
Figure 46: France Radiation-Hardened Electronics Market, 2019-2025
Figure 47: Russia Radiation-Hardened Electronics Market, 2019-2025
Figure 48: Spain Radiation-Hardened Electronics Market, 2019-2025
Figure 49: Rest-of-Europe Radiation-Hardened Electronics Market, 2019-2025
Figure 50: Asia-Pacific Radiation-Hardened Electronics Market, 2019–2025
Figure 51: China Radiation-Hardened Electronics Market, 2019-2025
Figure 52: Japan Radiation-Hardened Electronics Market, 2019-2025
Figure 53: South Korea Radiation-Hardened Electronics Market, 2019-2025
Figure 54: Australia Radiation-Hardened Electronics Market, 2019-2025
Figure 55: India Radiation-Hardened Electronics Market, 2019-2025
Figure 56: Rest-of-Asia-Pacific Radiation-Hardened Electronics Market, 2019-2025
Figure 57: Rest-of-the-World Radiation-Hardened Electronics Market, 2019-2025
Figure 58: Brazil Radiation-Hardened Electronics Market, 2019-2025

Figure 59: U.A.E. Radiation-Hardened Electronics Market, 2019-2025
Figure 60: South Africa Radiation-Hardened Electronics Market, 2019-2025
Figure 61: Mexico Radiation-Hardened Electronics Market, 2019-2025
Figure 62: Others Radiation-Hardened Electronics Market, 2019-2025
Figure 63: 3D Plus (HEICO Corporation): Financial Overview, 2017-2019
Figure 64: 3D Plus (HEICO Corporation): Segment Split, 2017-2019
Figure 65: 3D Plus (HEICO Corporation): Regional Split, 2017-2019
Figure 66: Analog Devices: Financial Overview, 2017-2019
Figure 67: Analog Devices: Segment Split, 2017-2019
Figure 68: Analog Devices: Regional Split, 2017-2019
Figure 69: Anaren Inc. (TTM Technologies): Financial Overview, 2017-2019
Figure 70: Anaren Inc. (TTM Technologies): Segment Split, 2017-2019
Figure 71: BAE Systems: Financial Overview, 2017-2019
Figure 72: BAE Systems: Segment Split, 2017-2019
Figure 73: Cobham PLC: Financial Overview, 2017-2018
Figure 74: Cobham PLC: Segment Split, 2017-2018
Figure 75: Cobham PLC: Regional Split, 2017-2018
Figure 76: Honeywell International Inc.: Financial Overview, 2017-2019
Figure 77: Honeywell International Inc.: Segment Split, 2017-2019
Figure 78: Honeywell International Inc.: Regional Split, 2017-2019
Figure 79: IBM Corporation.: Financial Overview, 2017-2019
Figure 80: IBM Corporation.: Segment Split, 2017-2019
Figure 81: IBM Corporation: Regional Split (2017-2019)
Figure 82: Infineon Technologies Inc.: Financial Overview, 2017-2019
Figure 83: Infineon Technologies Inc.: Segment Split, 2017-2019
Figure 84: Infineon Technologies Inc.: Regional Split, 2017-2019
Figure 85: Microchip Technology Inc: Financial Overview, 2018-2020
Figure 86: Microchip Technology Inc: Segment Split, 2018-2020
Figure 87: Microchip Technology Inc: Regional Split, 2018-2020
Figure 88: Renesas Electronics Corporation: Financial Overview, 2017-2019
Figure 89: STMicroelectronics N.V.: Financial Overview, 2017-2019
Figure 90: STMicroelectronics N.V.: Segment Split, 2017-2019
Figure 91: STMicroelectronics N.V.: Regional Split, 2017-2019
Figure 92: Texas Instruments Inc: Financial Overview (2017-2019)
Figure 93: Texas Instruments Inc: Segment Split, 2017-2019
Figure 94: Texas Instruments Inc: Regional Split, 2017-2019
Figure 95: Teledyne Technologies Incorporated: Financial Overview, 2017-2019
Figure 96: Teledyne Technologies Incorporated: Segment Split, 2017-2019
Figure 97: Teledyne Technologies Incorporated: Regional Split, 2017-2019

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Figure 98: The Boeing Company: Financial Overview, 2017-2019
Figure 99: The Boeing Company: Segment Split, 2017-2019
Figure 100: The Boeing Company: Regional Split, 2017-2019
Figure 101: Xilinx Inc.: Financial Overview, 2017-2018
Figure 102: Xilinx Inc.: Regional Split, 2017-2018
Figure 103: Global Radiation-Hardened Electronics (Market Segmentation)
Figure 104: Radiation-Hardened Electronics Market Research Methodology
Figure 105: Data Triangulation
Figure 106: Top-Down and Bottom-Up Approach
Figure 107: Global Radiation-Hardened Electronics Market Influencing Factors
Figure 108: Assumptions and Limitations

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